

Technical Data Data Sheet N0080, Rev. E



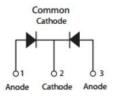
MBRF20100CT SCHOTTKY RECTIFIER



Features

- 175°C T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	100	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=133°C, rectangular wave form	10(Per Leg) 20(Per Device)	Α
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I _{FSM}	8.3ms, Half Sine pulse	150	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V _{F1}	@ 5A, Pulse, T₁ = 25 °C	0.76	0.80	V
		@ 10A, Pulse, T _J = 25 °C	0.85	0.90	V
	V_{F2}	@ 5A, Pulse, T _J = 125 °C	0.62	0.70	V
		@ 10A, Pulse, T _J = 125 °C	0.70	0.80	V
Reverse Current(Per Leg)*	I _{R1}	@V _R = rated V _R , T _J = 25 °C	0.002	1.0	mA
	I _{R2}	@V _R = rated V _R , T _J = 125 °C	0.3	15	mA
Repetitive peak reverse current	I _{RRM}	tp = 2 µs square F= 1 kHz	-	1	Α
Junction Capacitance(Per Leg)	C⊤	$@V_R = 5V, T_C = 25 ^{\circ}C, f_{SIG} = 1MHz$	200	300	pF
Series Inductance(Per Leg)	Ls	Measured lead to lead 5 mm from	8.0	_	nH
		package body	0.0		11111
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs
RSM Isolation Voltage	V _{ISO}	Clip mounting, the epoxy body away	-	4500	V
(t = 1.0 second, R. H. < =30%,		from the heatsink edge by more than			
T _A = 25 °C)		0.110" along the lead direction.			
·		Clip mounting, the epoxy body is inside	-	3500	
		the heatsink.			

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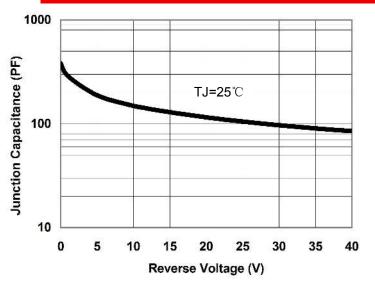


Technical Data Data Sheet N0080, Rev. E Screw mounting, the epoxy body is inside the heatsink. 1500

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _θ JC	DC operation	4.5	°C/W
Approximate Weight	wt	-	2	g
Case Style	ITO-220AB			

Ratings and Characteristics Curves



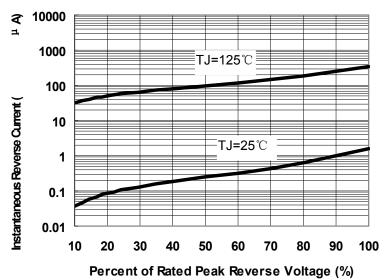


Fig.1-Typical Junction Capacitance

Fig.2-Typical Reverse Characteristics

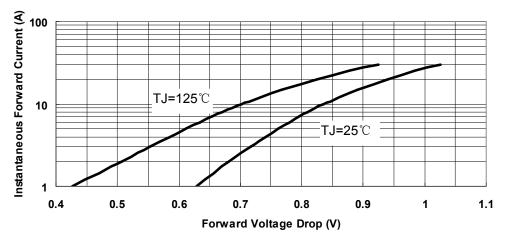


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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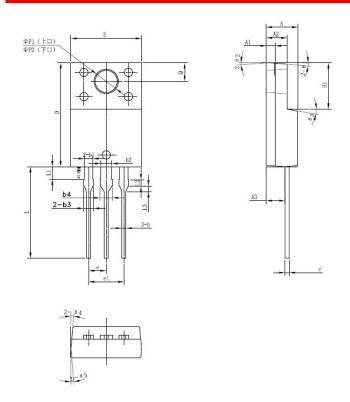
^{*} Pulse width < 300 µs, duty cycle < 2%



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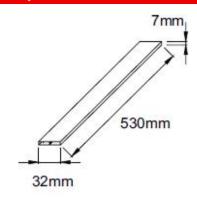


Mechanical Dimensions ITO-220AB

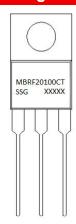


SYMBOL	Millimeters			
STWIBUL	MIN.	TYP.	MAX.	
Α	4.30	4.50	4.70	
A1	1.10	1.30	1.50	
A2	2.80	3.00	3.20	
A3	2.50	2.70	2.90	
b	0.50	0.60	0.75	
b1	1.10	1.20	1.35	
b2	1.50	1.60	1.75	
b3	1.20	1.30	1.45	
b4	1.60	1.70	1.85	
С	0.50	0.60	0.75	
D	14.80	15.00	15.20	
E	9.96	10.16	10.36	
е		2.55		
e1		5.10		
H1	6.50	6.70	6.90	
L	12.70	13.20	13.70	
L1	1.60	1.80	2.00	
L2	0.80	1.00	1.20	
L3	0.60	0.80	1.00	
ФР1(上□)	3.30	3.50	3.70	
ΦP2 (下口)	2.99	3.19	3.39	
Q	2.50	2.70	2.90	
Θ1		5°		
Θ2		4°		
Θ3		10°		
Θ4		5°		
Θ5		5°		

Tube Specification



Marking Diagram



Where XXXXX is YYWWL

MBR = Device Type
F = Package type
20 = Forward Current (20A)
100 = Reverse Voltage (100V)
CT = Configuration
SSG = SSG

 SSG
 = SSG

 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping
MBRF20100CT	ITO-220AB (Pb-Free)	50 pcs/ tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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